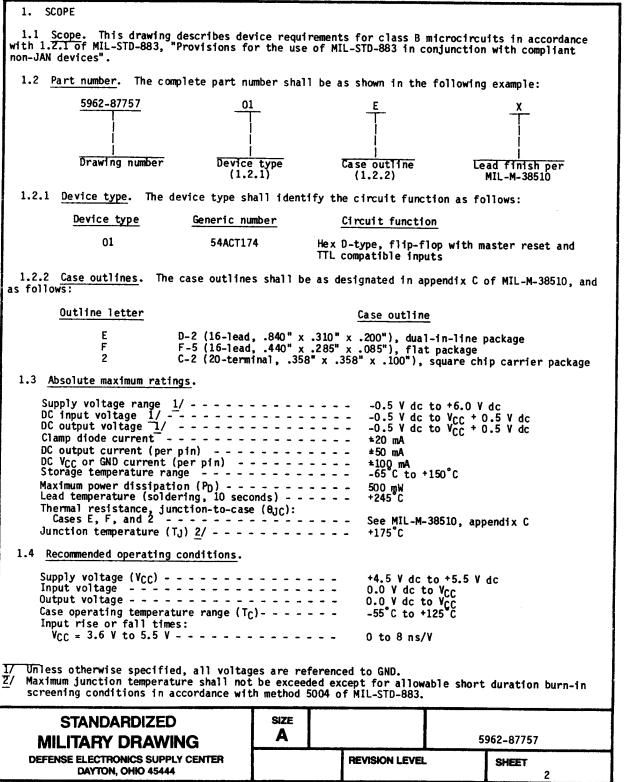
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Minimum setup time, Dn to CP $(t_s)$ : $T_C = +25  ^{\circ}C$ , $V_{CC} = 4.5  V$	3.0 ns 3.0 ns
Minimum hold time, Dn to CP ( $t_h$ ): $T_C = +25$ °C, $V_{CC} = 4.5$ V T <sub>C</sub> = -55°C to +125°C, $V_{CC} = 4.5$ V	2.0 ns 2.5 ns
Minimum pulse width CP (t <sub>w</sub> ):  TC = +25 C, V <sub>CC</sub> = 4.5 V	5.0 ns 6.2 ns
Maximum frequency $(f_{max})$ : $T_C = +25^{\circ}C$ , $V_{CC} = 4.5 V $	95 MHz 80 MHz
Minimum pulse width $\overline{MR}$ (t <sub>W</sub> ): $T_C = +25^{\circ}C$ , $V_{CC} = 4.5 \text{ V} $	5.0 ns 5.0 ns
Minimum recovery time, $\overline{MR}$ to CP (trem): $T_{C} = +25$ C, $V_{CC} = 4.5$ V T C = -55 C to +125 C, $V_{CC} = 4.5$ V	1.5 ns 1.5 ns

## 2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

**SPECIFICATION** 

**MILITARY** 

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

- 2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.
  - 3. REQUIREMENTS
- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

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- 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
- 3.2.2 Truth table. The truth table shall be as specified on figure 2.
- 3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.
- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-SID-883 (see 3.1 herein).
- 3.8 <u>Verification and review.</u> DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
  - a. Burn-in test, method 1015 of MIL-STD-883.
    - Test condition A, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
    - (2)  $T_A = +125^{\circ}C$ , minimum.
  - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

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	TABLE	I. Electr	ical perfo	rmance characteris	tics.		•	<u> </u>	
Test	Symbol	   -55°	Condition C < T <sub>C</sub> <	ns +125°C e specified	Group A	Lim	its     Max	Unit	
High level output 1/ voltage	т I V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub>  I <sub>OH</sub> = -50	or V <sub>II</sub>	V <sub>CC</sub> = 4.5 V	1, 2, 3	4.4	1	V	
·				V <sub>CC</sub> = 5.5 V	<u> </u>	5.4		Ī	
	 	  V <sub>IN</sub> = V <sub>IH</sub>  I <sub>OH</sub> = -24	or V <sub>IL</sub>	V <sub>CC</sub> = 4.5 V		3.7		<u> </u>	
			B-2	V <sub>CC</sub> = 5.5 V		4.7		Ţ	
	 	VIN = VIH	or V <sub>IL</sub> mA	V <sub>CC</sub> = 5.5 V	 	3.85			
Low level output 1/voltage	VOL	  V <sub>IN</sub> = V <sub>IH</sub>  I <sub>OL</sub> = 50 μ	or V <sub>IL</sub>	V <sub>CC</sub> = 4.5 V	1, 2, 3		0.1	V	
		 		V <sub>CC</sub> = 5.5 V			0.1	T   	
	!	  V <sub>IN</sub> = V <sub>IH</sub>  I <sub>OH</sub> = 24 m	or V <sub>IL</sub>	V <sub>CC</sub> = 4.5 V			0.5	T   	
				V <sub>CC</sub> = 5.5 V			0.5	T   <u> </u>	
	     	 	or V <sub>IL</sub> A	V <sub>CC</sub> = 5.5 V		 	1.65	     	
High level input voltage	VIH	<u>2</u> /		V <sub>CC</sub> = 4.5 V	1, 2, 3	2.0		٧	
				V <sub>CC</sub> = 5.5 V	T	2.0		T   	
Low level input voltage	VIL	<u>2</u> /		V <sub>CC</sub> = 4.5 V	1, 2, 3		0.8	T	
	   			V <sub>CC</sub> = 5.5 V			0.8	T   	
Input leakage current	I <sub>IL</sub>	V <sub>IN</sub> = 0.0	٧	V <sub>CC</sub> = 5.5 V	1, 2, 3		-1.0	μA	
	IIH	V <sub>IN</sub> = 5.5	٧			Ţ ! !	1.0	Γ   	
See footnotes at end o	f table.								
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TABI	E I. <u>E</u> 1	ectrical performance c	naracteristics -	Continued.			
Test	Symbol		1/50	Group A	Lin	  Unit	
		unless otherwise s	pecified	subgroups	Min	Max	<u> </u>
Input capacitance	CIN	See 4.3.1c		4		10	pF
Power dissipation capacitance 3/	C <sub>PD</sub>	  See 4.3.1c 		4		60	T     
Functional tests	 	Tested at V <sub>CC</sub> = 3.0 V lat V <sub>CC</sub> = 5.5 V, see 4.	7, 8	· · · · · · · · · · · · · · · · · · ·	<del>                                     </del>	†     	
Quiescent current	Icc		or GND	1, 2, 3	-	160	μА
Maximum I <sub>CC</sub> /TTL <u>4</u> / inputs high	AICC			1, 2, 3		1.6	mA
Propagation delay time High to low 5/	tpHL,	  C <sub>L</sub> = 50 pF  R <sub>L</sub> = 500Ω	V <sub>CC</sub> = 4.5 V	9	1.0	10.5	ns
Low to high CP to QN	· =··   	"  See figure 3 	V <sub>CC</sub> = 4.5 V	10, 11	1.0	14.0	T 
	t <sub>PHL</sub> ,	  C <sub>L</sub> = 50 pF  R <sub>L</sub> = 500Ω	V <sub>CC</sub> = 4.5 V	9	1.0	11.5	ns
Low to high MR to QN		=  See figure 3	V <sub>CC</sub> = 4.5 V	10, 11	1.0	15.5	

- 1/  $V_{OH}$  and  $V_{OL}$  tests will be tested at  $V_{CC}$  = 4.5 V.  $V_{OH}$  and  $V_{OL}$  are guaranteed, if not tested, for other values of  $V_{CC}$ . Limits snown apply to operation at  $V_{CC}$  = 5.0 V  $\pm$  0.5 V. Transmission driving tests are performed at  $V_{CC}$  = 5.5 V with a 2 ms duration maximum.
- $\underline{2}/$  V<sub>IH</sub> and V<sub>IL</sub> tests are guaranteed by the V<sub>OH</sub> and V<sub>OL</sub> tests.
- $\frac{3/}{-} \begin{array}{l} \text{Power dissipation capacitance (Cpp), determines the dynamic power consumption, } P_D = (CpD) \\ + C_L)_{VCC}^{CC}_{f}^{f} + I_{CC}^{CC}_{CC}, \text{ and the dynamic current consumption (} I_S) \text{ is } I_S = (CpD) \\ + C_L)_{VCC}^{CC}_{CC}^{f} + I_{CC}. \end{array}$
- 4/  $\Delta I_{CC}(max)/pin < 1.6$  mA (preferred method), or  $\Delta I_{CC}/package \le 1.6$  mA x number of input pins/package where  $\Delta I_{CC}(max)/data$  pin  $\le 1.6$  mA and  $\Delta I_{CC}(max)/control$  pin  $\le 3.0$  mA (alternate method).
- $^{5/}$  AC limits at 5.5 V V<sub>CC</sub> are equal to limits at 4.5 V V<sub>CC</sub> and guaranteed by testing at 4.5 V V<sub>CC</sub>. Minimum ac guaranteed for 5.5 V V<sub>CC</sub> by guardbanding 4.5 V V<sub>CC</sub> limits to 1.5 ns minimum.

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Device type	01	
Case outlines	E, F	2
Terminal number	Termina1	symbol
1 2 3 4 4 5 6 7 8 9 10 11 12 13 14 15	MR Q0 D0 D1 Q1 Q2 GND CP Q3 D3 Q4 D4 D5	NC   MR   QO   DO   NC   D1   D2   Q2   GND   NC   CP   Q3   Q3   Q4   Q4
16 17 18 1 18 1 19 1 20	Vcc	NC   D4   D5   Q5   VCC

FIGURE 1. Terminal connections.

l In	puts	  Output 	
MR	ICP	Dn	Qn
IL IH IH IH		IX IH IL IX	L H L Q

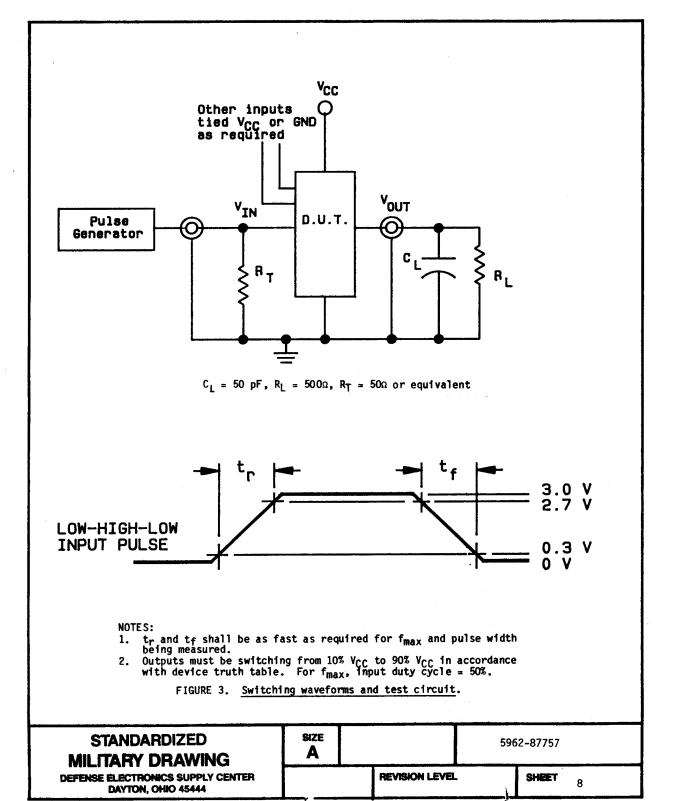
FIGURE 2. <u>Truth table</u>.

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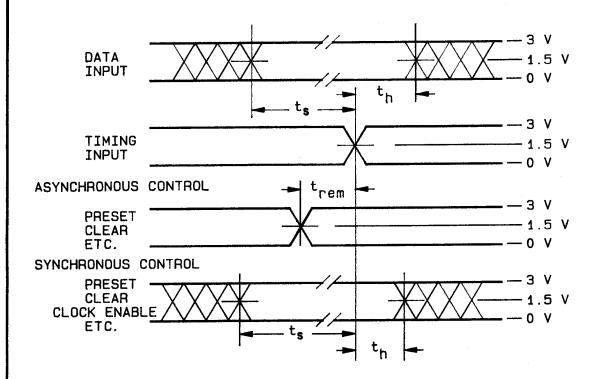
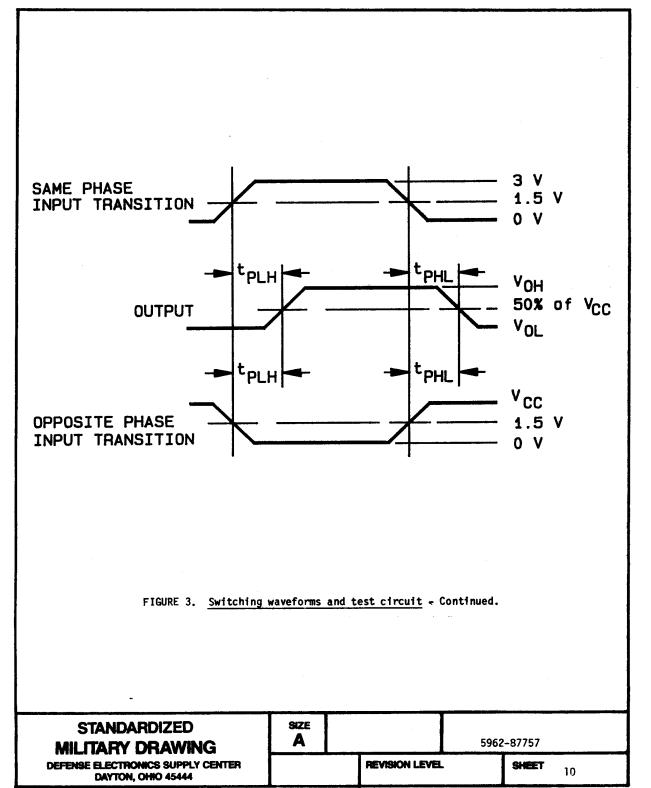
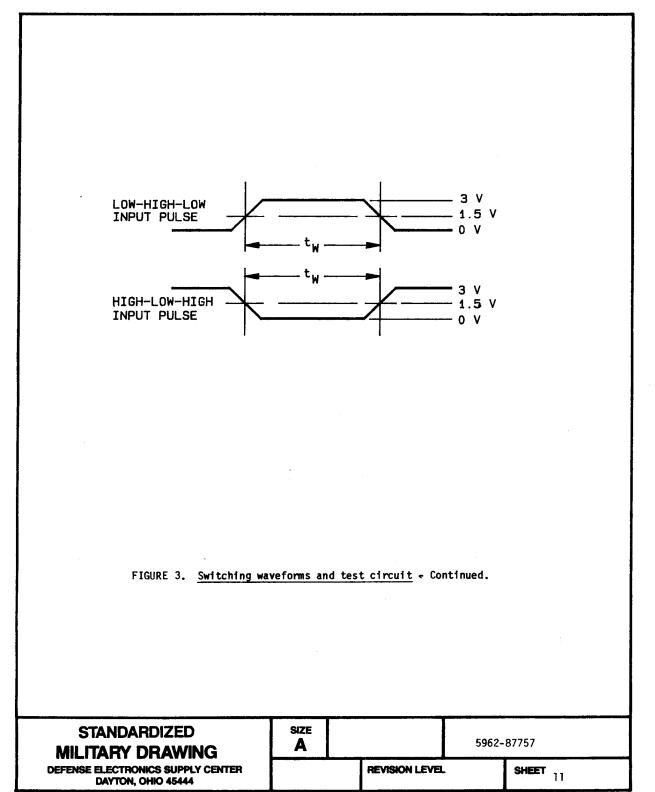


FIGURE 3. Switching waveforms and test circuit - Continued.

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- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
  - 4.3.1 Group A inspection.
    - a. Tests shall be as specified in table II herein.
    - b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
    - c. Subgroup 4 ( $C_{IN}$  and  $C_{PD}$  measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance. Test all applicable pins on 5 devices with zero failures.
    - d. Subgroups 7 and 8 shall verify the truth table as specified on figure 2 herein.
  - 4.3.2 Groups C and D inspections.
    - a. End-point electrical parameters shall be as specified in table II herein.
    - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
      - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
      - (2)  $T_A = +125^{\circ}C$ , minimum.
      - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

TABLE II. <u>Electrical test requirements</u>.

   MIL-STD-883 test requirements   	Subgroups   (per method   5005, table I)
  Interim electrical parameters   (method 5004)	   
  Final electrical test parameters   (method 5004)	11*, 2, 3, 7,   8, 9
  Group A test requirements   (method 5005)	11, 2, 3, 4, 7, 8, 9, 10, 11
  Groups C and D end-point   electrical parameters   (method 5005)	1, 2, 3

<sup>\*</sup> PDA applies to subgroup 1.

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## PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with

## 6. NOTES

- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.
- 6.4 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor   CAGE   number	Yendor 1/   similar part   number	Replacement military specification
5962-8775701EX	27014 18714	54ACT174/DMQB CD54ACT174/3A	   M38510/75653BRX
5962-8775701FX	27014	   54ACT174/FMQB 	M38510/75653BSX
5962-87757012X	27014	54ACT174/LMQB	M38510/7565382X

Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

Vendor name and address

27014

National Semiconductor 333 Western Avenue South Portland, ME 04106

18714

GE/RCA Solid State Route 202 Somerville, NJ 08876-0591

STANDARDIZED MILITARY DRAWING

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